ACPL-M43T

Wide Operating Temperature Automotive Digital Optocoupler with R²Coupler™ Isolation and 5-Pin SMT Package

Data Sheet

Lead (Pb) Free
RoHS 6 fully compliant

RoHS 6 fully compliant options available;
-xxxE denotes a lead-free product

Description

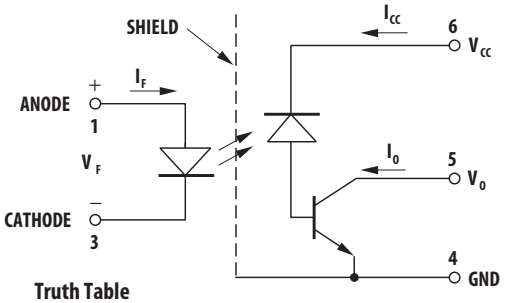
The ACPL-M43T is a single channel, high temperature, high CMR, high speed digital optocoupler in a five lead miniature footprint specifically used in the automotive applications. The SO-5 JEDEC registered (MO-155) package outline does not require "through holes" in a PCB. This package occupies approximately one-fourth the footprint area of the standard dual-in-line package. The lead profile is designed to be compatible with standard surface mount processes.

This digital optocoupler uses an insulating layer between the light emitting diode and an integrated photon detector to provide electrical insulation between input and output. Separate connections for the photodiode bias and output transistor collector increase the speed up to a hundred times over that of a conventional photo-transistor coupler by reducing the base-collector capacitance.

The ACPL-M43T has an increased common mode transient immunity of 30kV/µs minimum at V_{CM} = 1500V over extended temperature range.

Avago R²Coupler isolation products provide the reinforced insulation and reliability needed for critical in automotive and high temperature industrial applications.

Functional Diagram



Truth Table

LED	Vo
ON	LOW
OFF	HIGH

Note: The connection of a 0.1 F bypass capacitor between pins 4 and 6 is recommended.

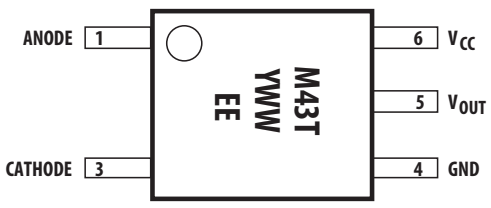
Features

- High Temperature and Reliability IPM Driver for Automotive Application.
- 30 kV/µs High Common-Mode Rejection at V_{CM} = 1500 V (typ)
- Compact, Auto-Insertable SO5 Packages
- Wide Temperature Range: -40°C ~ 125°C
- High Speed: 1MBd (Typ)
- Low LED Drive Current: 10mA (typ)
- Low Propagation Delay: 300ns (typ)
- Qualified to AEC-Q100 Test Guidelines
- Worldwide Safety Approval:
  - UL1577 recognized, 4000Vrms/1min
  - CSA Approved
  - IEC/EN/DIN EN 60747-5-2 Approved

Applications

- Automotive IPM Driver for DC-DC converters and motor inverters
- CANBus Communications Interface
- High Temperature Digital/Analog Signal Isolation
- Power Transistor Isolation

Pin Connections



CAUTION: *It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD.*

Ordering Information

Part number	Option RoHS Compliant	Package	Surface Mount	Tape & Reel	IEC/EN/DIN EN 60747-5-2	Quantity
ACPL-M43T	-000E	SO-5	X			100 per tube
	-060E		X		X	100 per tube
	-500E		X	X		1500 per reel
	-560E		X	X	X	1500 per reel

To order, choose a part number from the part number column and combine with the desired option from the option column to form an order entry.

Example 1:

ACPL-M43T-500E to order product of Mini-flat Surface Mount 5-pin package in Tape and Reel packaging with RoHS compliant.

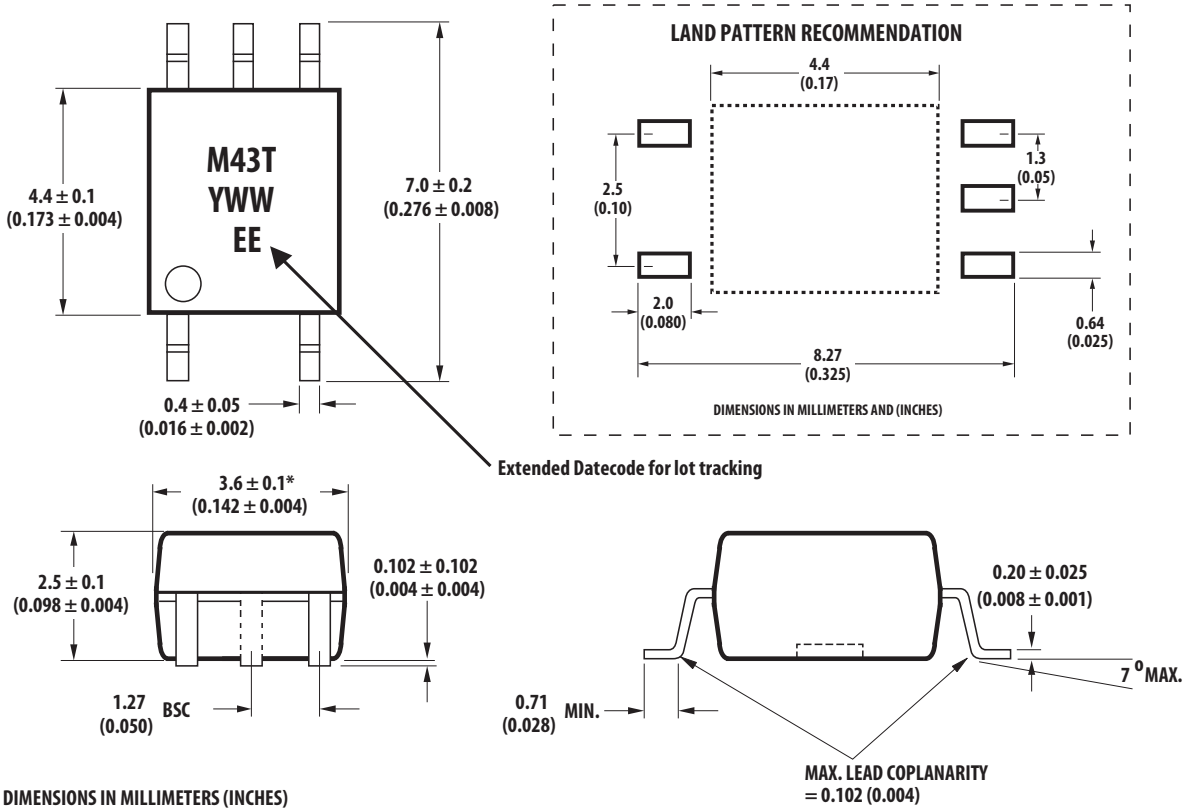
Example 2:

ACPL-M43T to order product of Mini-flat Surface Mount 5-pin package in tube packaging and non RoHS compliant.

Option datasheets are available. Contact your Avago sales representative or authorized distributor for information.

Package Outline Drawings

ACPL-M43T Small Outline SO-5 Package (JEDEC MO-155)



DIMENSIONS IN MILLIMETERS (INCHES)

* MAXIMUM MOLD FLASH ON EACH SIDE IS 0.15 mm (0.006)

NOTE: FLOATING LEAD PROTRUSION IS 0.15 mm (6 mils) MAX.

Recommended reflow condition as per JEDEC Standard, J-STD-020 (latest revision).

Note: Non-halide flux should be used.

Regulatory Information

The ACPL-M43T is approved by the following organizations:

UL

Approved under UL 1577, component recognition program up to V_{ISO} = 4000 V_{RMS}

CSA

Approved under CSA Component Acceptance Notice #5.

IEC/EN/DIN EN 60747-5-2

Approved under:
IEC 60747-5-5:2007
EN 60747-5-2:2001 + A1
DIN EN 60747-5-2 (VDE 0884 Teil 2)

IEC/EN/DIN EN 60747-5-2 Insulation Characteristics*

Description	Symbol	Characteristic	Unit
Installation classification per DIN VDE 0110/1.89, Table 1			
for rated mains voltage ≤ 150 V_{rms}		I – IV	
for rated mains voltage ≤ 300 Vrms		I – III	
for rated mains voltage ≤ 600 V_{rms}		I – II	
Climatic Classification		55/125/21	
Pollution Degree (DIN VDE 0110/1.89)		2	
Maximum Working Insulation Voltage	V_{IORM}	567	V_{peak}
Input to Output Test Voltage, Method b* V_{IORM} x 1.875=V_{PR}, 100% Production Test with t_m=1 sec, Partial discharge < 5 pC	V_{PR}	1063	V_{peak}
Input to Output Test Voltage, Method a* V_{IORM} x 1.6=V_{PR}, Type and Sample Test, t_m=10 sec, Partial discharge < 5 pC	V_{PR}	907	V_{peak}
Highest Allowable Overvoltage (Transient Overvoltage t_{ini} = 60 sec)	V_{IOTM}	6000	V_{peak}
Safety-limiting values – maximum values allowed in the event of a failure.			
Case Temperature	T_S	175	°C
Input Current	$I_{S, INPUT}$	230	mA
Output Power	$P_{S, OUTPUT}$	600	mW
Insulation Resistance at T_S, V_{IO} = 500 V	R_S	$>10^9$	Ω

* Refer to the optocoupler section of the Isolation and Control Components Designer's Catalog, under Product Safety Regulations section, (IEC/EN/DIN EN 60747-5-2) for a detailed description of Method a and Method b partial discharge test profiles.

Insulation and Safety Related Specifications

Parameter	Symbol	ACPL-M43T	Units	Conditions
Minimum External Air Gap (Clearance)	L(101)	5	mm	Measured from input terminals to output terminals, shortest distance through air.
Minimum External Tracking (Creepage)	L(102)	5	mm	Measured from input terminals to output terminals, shortest distance path along body.
Minimum Internal Plastic Gap (Internal Clearance)		0.08	mm	Through insulation distance conductor to conductor, usually the straight line distance thickness between the emitter and detector.
Tracking Resistance (Comparative Tracking Index)	CTI	175	V	DIN IEC 112/VDE 0303 Part 1
Isolation Group (DIN VDE0109)		IIIa		Material Group (DIN VDE 0109)

Absolute Maximum Ratings

Parameter		Symbol	Min.	Max.	Units	Note
Storage Temperature		T_S	-55	150	°C	
Operating Temperature		T_A	-40	125	°C	
Lead Soldering Cycle	Temperature			260	°C	
	Time			10	s	
Average Forward Input Current		$I_{F(avg)}$		20	mA	
Peak Forward Input Current (50% duty cycle, 1ms pulse width)		$I_{F(peak)}$		40	mA	
Peak Transient Input Current (<= 1us pulse width, 300ps)		$I_{F(trans)}$		100	mA	
Reversed Input Voltage		V_R		5	V	Pin 3 - 1
Input Power Dissipation		P_{IN}		30	mW	
Output Power Dissipation		P_O		100	mW	
Average Output Current		I_O		8	mA	
Peak Output Current		Io(pk)		16	mA	
Supply Voltage (Pins 6-4)		V_{CC}	-0.5	30	V	
Output Voltage (Pins 5-4)		V_O	-0.5	20	V	
Solder Reflow Temperature Profile		See Reflow Temperature Profile				

Recommended Operating Conditions

Parameter	Symbol	Min.	Max.	Units	Note
Supply Voltage	V_{CC}	3.0	20.0	V	
Operating Temperature	T_A	-40	125	°C	

Electrical Specifications (DC)

Over recommended operating T_A = -40°C to 125°C, unless otherwise specified.

Parameter	Sym.	Min.	Typ.	Max.	Units		Conditions		Fig.	Note
Current Transfer Ratio	CTR	32	45	80	%	T_A=25°C	Vo=0.4V	Vcc=4.5V I_F=10mA	1,2,4	1
		20	45		%		Vo=0.5V			
Logic Low Output Voltage	V_{OL}		0.1	0.4	V	T_A=25°C	Io=3mA			
				0.5	V		Io=2.4mA			
Logic High Output Current	I_{OH}			0.5	µA	T_A=25°C	Vo=Vcc=5.5V	I_F=0mA	11, 12	
				1	µA	T_A=25°C	Vo=Vcc=20V			
				5	µA					
Logic Low Supply Current	I_{CCL}		50	200	µA		I_F=10mA, Vo=open, Vcc=20V			7
Logic High Supply Current	I_{CCH}		0.02	1	µA	T_A=25°C	I_F=0mA, Vo=open, Vcc=20V			7
				2.5	µA					
Input Forward Voltage	V_F	1.45	1.5	1.75	V	T_A=25°C	I_F=10mA		3	
		1.25	1.5	1.85	V		I_F=10mA			
Input Reversed Breakdown Voltage	BV_R	5			V		I_R=10µA			
Temperature Coefficient of Forward Voltage	$\Delta V/\Delta T_A$		-1.5		mV/°C		I_F=10mA			
Input Capacitance	C_{IN}		90		pF		F=1MHz, V_F=0			

Switching Specifications (AC)

Over recommended operating (T_A = -40°C to 125°C), I_F = 10mA, V_{CC} = 5.0 V unless otherwise specified.

Parameter	Symbol	Min	Typ	Max	Units		Test Conditions	Fig.	Note
Propagation Delay Time to Logic Low at Output	T_{PHL}	0.08	0.2	0.8	µs	T_A=25°C	Pulse: f=10kHz, Duty cycle =50%, I_F = 10mA, V_{CC} = 5.0 V, R_L = 1.9kΩ, C_L = 15pF V_{THHL}=1.5V	5,6,7, 8,9, 10,13	5
		0.06		1.0	µs				
Propagation Delay Time to Logic High at Output	T_{PLH}	0.15	0.3	0.8	µs	T_A=25°C	Pulse: f=10kHz, Duty cycle =50%, I_F = 10mA, V_{CC} = 5.0 V, R_L = 1.9kΩ C_L = 15pF V_{THLH}=2.0V	5,6,7, 8,9, 10,13	5
		0.03		1.0	µs				
Pulse Width Distortion	PWD	0	0.4	0. 45	µs	T_A=25°C	Pulse: f=10kHz, Duty cycle =50%, I_F=10mA, V_{CC}=5.0V, R_L=1.9kΩ, C_L=15pF, V_{THHL}=1.5V, V_{THLH}=2.0V		8
		0		0.85	µs				
Propagation Delay Difference Between Any 2 Parts	t_{PLH}-t_{PHL}	0	0.4	0.5	µs	T_A=25°C	Pulse: f=10kHz, Duty cycle =50%, I_F=10mA, V_{CC}=5.0V, R_L=1.9kΩ, C_L=15pF, V_{THHL}=1.5V, V_{THLH}=2.0V		9
		0		0.9	µs				
Common Mode Transient Immunity at Logic High Output	$\|CM_H\|$	15	30		kV/µs		V_{CM}=1500Vp-p, I_F=0mA, T_A=25°C, R_L=1.9kΩ	14	4, 5
Common Mode Transient Immunity at Logic Low Output	$\|CM_L\|$	15	30		kV/µs		V_{CM}=1500Vp-p, I_F=10mA, T_A=25°C, R_L=1.9kΩ	14	

Package Characteristics

*The Input-Output Momentary Withstand Voltage is a dielectric voltage rating that should not be interpreted as an input-output continuous voltage rating.

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions	Fig.	Note
Input-Output Momentary Withstand Voltage*	V_{ISO}	4000			V_{RMS}	RH ≤ 50%, t = 1 min; T_A = 25°C		2, 3
Input-Output Resistance	R_{I-O}		10^{14}		Ω	V_{I-O} = 500 Vdc		2
Input-Output Capacitance	C_{I-O}		0.6		pF	f = 1 MHz; V_{I-O} = 0 Vdc		2

Notes:

1. CURRENT TRANSFER RATIO in percent is defined as the ratio of output collector current, I_O, to the forward LED input current, I_F, times 100.
2. Device considered a two terminal device: pins 1 and 3 shorted together, and pins 4, 5 and 6 shorted together.
3. In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage ≥ 4800 V_{RMS} for 1 second.
4. Common transient immunity in a Logic High level is the maximum tolerable (positive) dV_{CM}/dt on the rising edge of the common mode pulse, V_{CM}, to assure that the output will remain in a Logic High state (i.e., V_O > 2.0 V). Common mode transient immunity in a Logic Low level is the maximum tolerable (negative) dV_{CM}/dt on the falling edge of the common mode pulse signal, V_{CM} to assure that the output will remain in a Logic Low state (i.e., V_O < 0.8 V).
5. The 1.9 kΩ load represents 1 TTL unit load of 1.6 mA and the 5.6 kΩ pull-up resistor.
6. The frequency at which the ac output voltage is 3 dB below its mid-frequency value.
7. Use of a 0.1 µF bypass capacitor connected between pins 4 and 6 is recommended.
8. Pulse Width Distortion (PWD) is defined as $|t_{PHL} - t_{PLH}|$ for any given device.
9. The difference between t_{PLH} and t_{PHL} between any two parts under the same test condition.

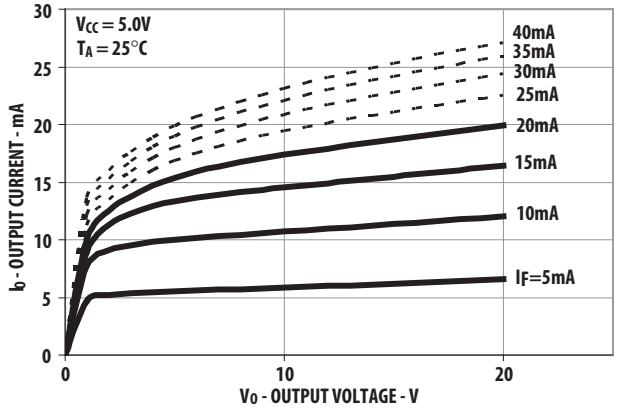


Figure 1. DC and Pulsed Transfer Characteristics.

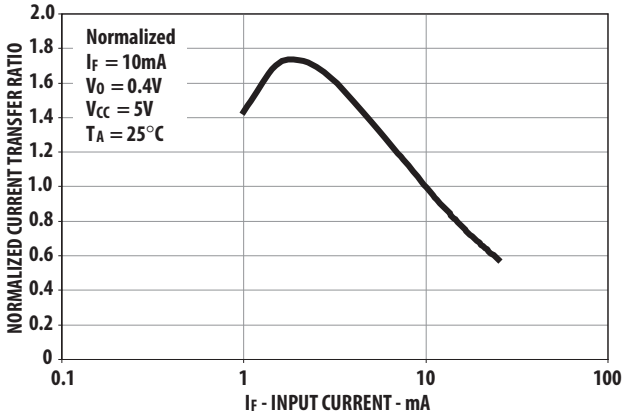


Figure 2. Current Transfer Ratio vs Input Current

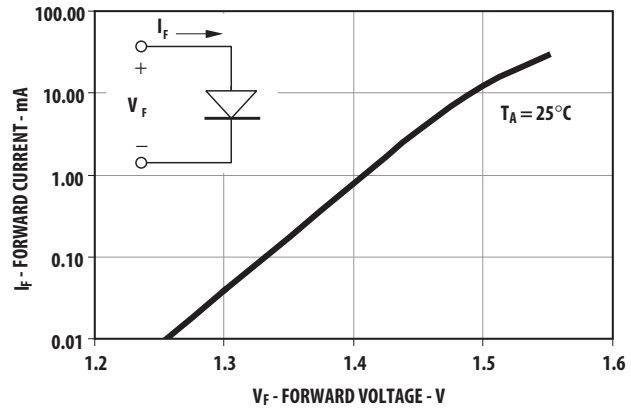


Figure 3. Input Current vs Forward Voltage

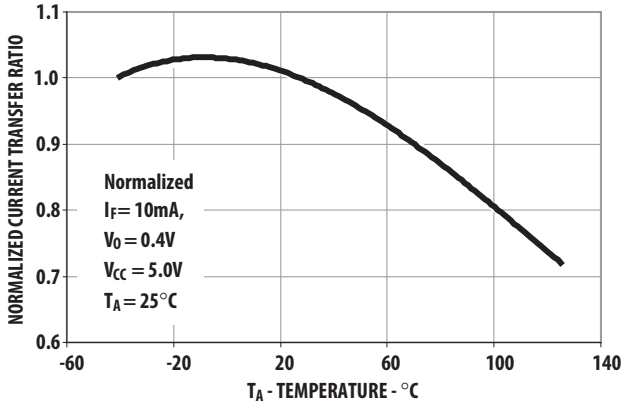


Figure 4. Current Transfer Ratio vs Temperature

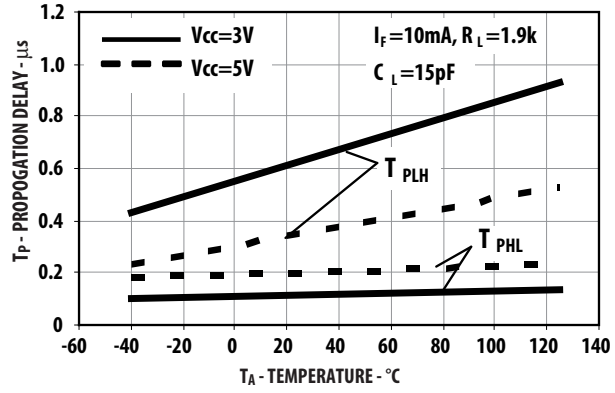


Figure 5. Propagation Delay vs Temperature

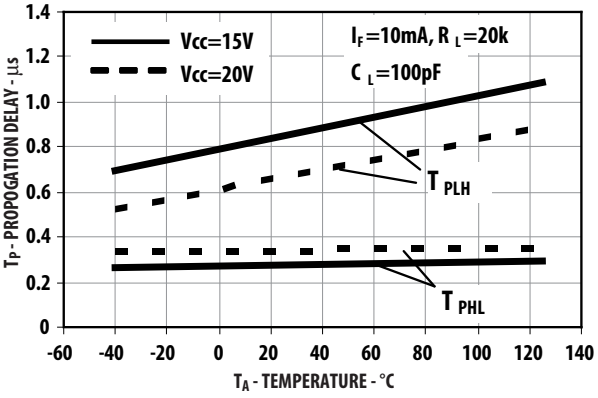


Figure 6. Propagation Delay vs Temperature

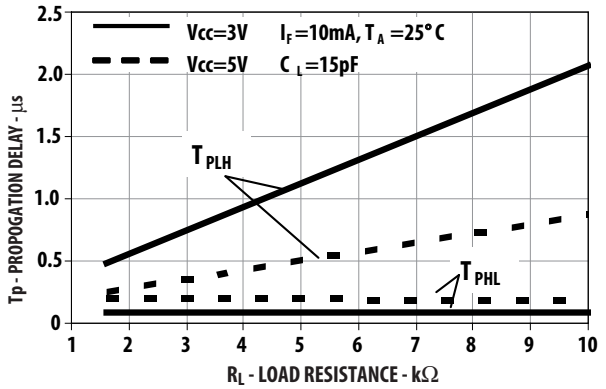


Figure 7. Propagation Delay Time vs Load Resistance

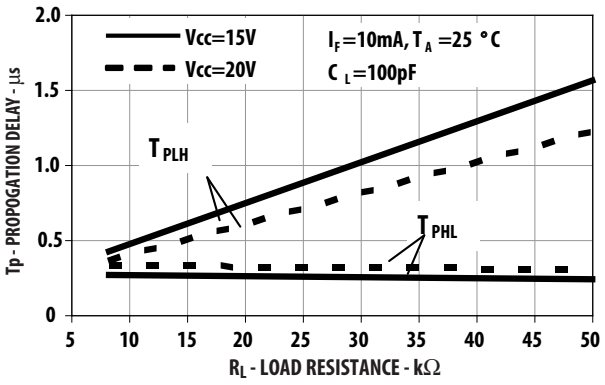


Figure 8. Propagation Delay Time vs Load Resistance

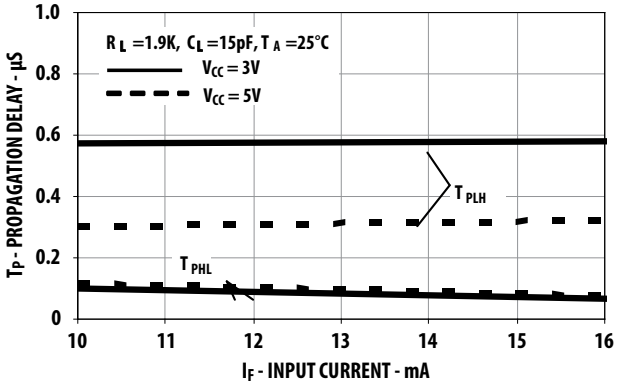


Figure 9. Propagation Delay Time vs Input Current

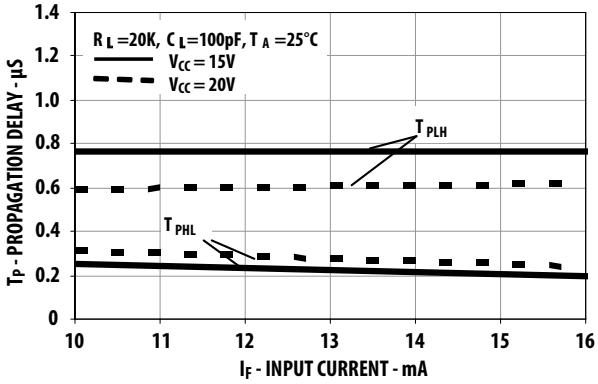


Figure 10. Propagation Delay Time vs Input Current

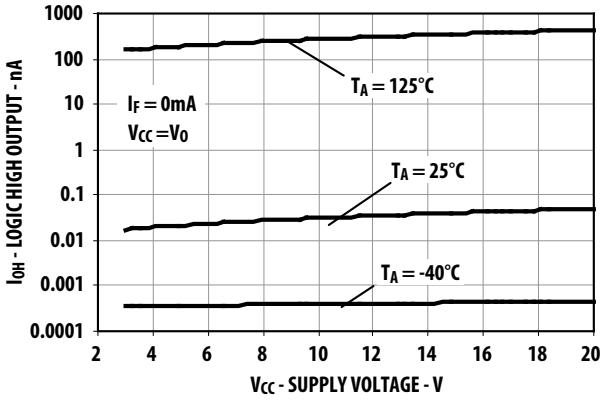


Figure 11. Logic High Output Current vs Supply Voltage

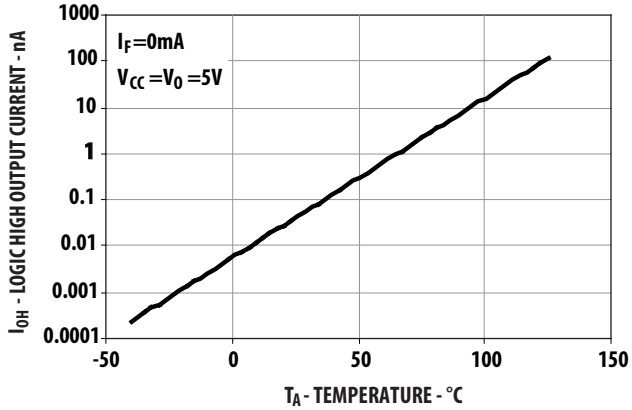


Figure 12. Logic High Output Current vs Temperature

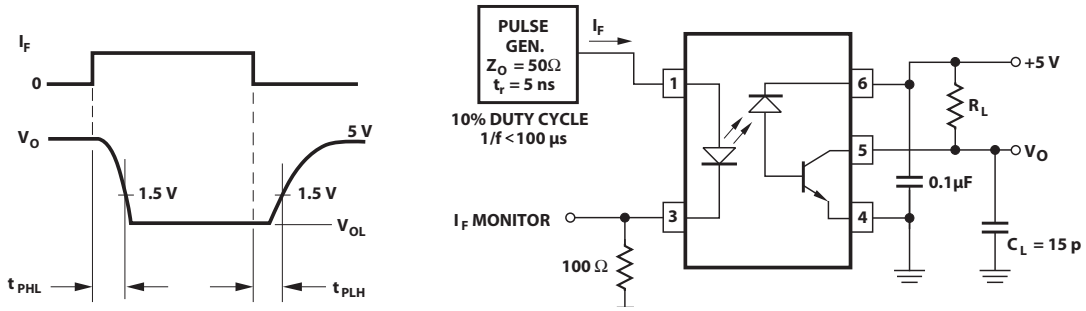


Figure 13. Switching Test Circuit

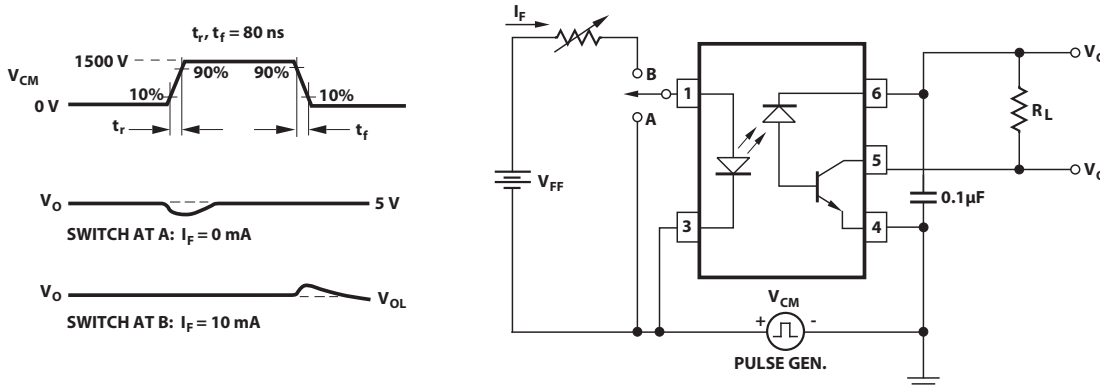


Figure 14. Test Circuit for Transient Immunity and Typical Waveforms.

AV02-0565EN - December 1, 2011